

ABSTRACT

It is to provide an electronic component packaging container excellent in mechanical strength.

An electronic component packaging container which
5 comprises a multilayer polyester sheet having a base
layer comprising a polyethylene terephthalate type resin
and a polycarbonate type resin and a surface layer
comprising a polycarbonate type resin, formed on at least
one side of the base layer, wherein the base layer
10 contains from 70 to 97 wt% of the polyethylene
terephthalate type resin and from 3 to 30 wt% of the
polycarbonate type resin based on the total amount of the
polyethylene terephthalate type resin and the
polycarbonate type resin, and the thickness of the
15 surface layer is from 10 to 30% of the total thickness.

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